

Next edition of C63.4 Status Report Emission Measurements

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Chair

C63.4 Maintenance team

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C63.4-201X WG members

Name	Role within C63.4 WG	Affiliation
Heirman, Don	Chair	Don HEIRMAN Consultants
Hodes, Harry	Vice Chair	Bay Area Compliance Laboratory
Ramie, Jerry	Secretary	ARC Technical Resources, Inc.
Arthurs, Mark	Member	Sony
Chen, Zhong	Member	ETS-Lindgren
Crumm, Allen	Member	Consultant
DeLisi, Bob	Member	UL LLC
Griffin, Andy	Member	CISCO Systems
Harrington, Tim	Member	FCC
Hofmann, Bob	Member	Hofmann EMC Engineering
Hoolihan, Dan	Member	Hoolihan EMC Consulting
Jones, Steve	Member	FCC
Lombardi, Rick	Member	Visteon Corporation / SAE Primary
O'Dwyer, Michael	Member	Apple, Inc.
Popovici, Horia	Member	ISED Canada
Samoto, Mits	Member	Liberty Labs Asia
Schafer, Werner	Member	Schaefer Associates
Sigouin, Dan	Member	DHS-EMC
Zainal, Khairul	Member	LS Research
Zimmerman, Dave	Member	Spectrum EMC

C63.4-201X

- **PINS-C approved by WG, SC1 and C63 (Nov 2014)**
 - 21 proposals for work narrowed down initially to 9; those not of high priority were identified and reasons given in C63 voting document
- **PINS-C study question processes well underway**
 - It presents what should initially be studied for the next edition of C63.4;
 - Objective is to form a PINS to start in earnest revisions
- **WG meeting held 5/9/16--1300 to 1500**

Monday 5/9/16 Meeting

- Reviewed the 9 topics to consider first
 - Measurement methods above 1 GHz-rnd robin test
 - Use of multiple antenna masts/antennas in SAC
 - Remove absorber “patch” option above 1 GHz
 - Way forward with 2 dB “rule”
 - Tolerances for dimensional requirements
 - Adding phase requirements for LISNs
 - Harmonizing visual displays with CISPR 2-or not
 - Revisiting antenna bore citing
 - Handling approved interpretations

Monday 5/9/16 Meeting

- Next steps for C63.4 project:
 - Continue research work
 - Form PINS for SC/1 to move it to C63 for approval by email in third quarter 2016
 - Draft changes for review by first quarter 2017
 - Ready for balloting process by mid 2017
 - Publish by early 2018